High Temperature 135°C, Resin-molded Chip, High Reliability





FEATURES

- Compliant to the RoHS3 directive 2015/863/EU
- High Temperature 135°C
- AEC-Q200 Qualified
- Failure Rate Level 0.5%/ 1000 hrs
- 100% Surge Current Tested

APPLICATIONS

- Automotive Electronics (Engine ECU, Transmission, Oil Pump)
- Industrial Equipment

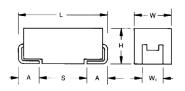




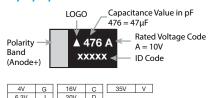
CASE DIMENSIONS: millimeters (inches)

Code	EIA Code	EIA Metric	L ± 0.20 (0.008)	W ± 0.20 (0.008) -0.10 (0.004)	H ± 0.20 (0.008) -0.10 (0.004)	W ₁ ± 0.20 (0.008)	A ± 0.30 (0.012) -0.20 (0.008)	S Min.
Α	1206	3216-18	3.20 (0.126)	1.60 (0.063)	1.60 (0.063)	1.20 (0.047)	0.80 (0.031)	1.10 (0.043)
В	1210	3528-21	3.50 (0.138)	2.80 (0.110)	1.90 (0.075)	2.20 (0.087)	0.80 (0.031)	1.40 (0.055)
С	2312	6032-28	6.00 (0.236)	3.20 (0.126)	2.60 (0.102)	2.20 (0.087)	1.30 (0.051)	2.90 (0.114)
N	2917	7343-31	7.30 (0.287)	4.30 (0.169)	2.90 (0.114)	2.40 (0.094)	1.30 (0.051)	4.40 (0.173)

W, dimension applies to the termination width for a dimensional area only



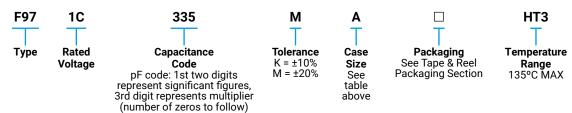
A, B, C, N CASE



^{*}Capacitance code of "P" case products are as shown below.

HOW TO ORDER

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TECHNICAL SPECIFICATIONS

Category Temperature Range	-55 to +135°C
Rated Temperature	+95°C
Capacitance Tolerance	±20%, ±10% at 120Hz
Dissipation Factor	Refer to next page
ESR 100kHz	Refer to next page
Leakage Current*	After 1 minute's application of rated voltage, leakage current at 20°C is not more than 0.01CV or 0.5μA, whichever is greater.
	After 1 minute's application of rated voltage, leakage current at 95°C is not more than 0.1CV or 5µA, whichever is greater.
	After 1 minute's application of derated voltage, leakage current at 135°C is not more than 0.125CV or 6.3µA, whichever is greater.
Capacitance Change By Temperature	+15% Max. at +125°C
	+10% Max. at +85°C
	-10% Max. at -55°C

^{*}As for the surge voltage and derated voltage at 135°C, refer to page precautions for details.



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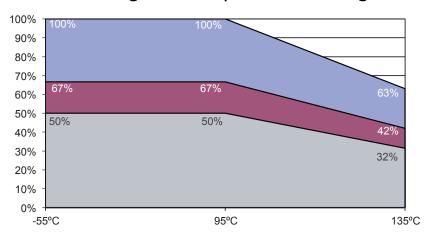
CAPACITANCE AND RATED VOLTAGE RANGE (LETTER DENOTES CASE SIZE)

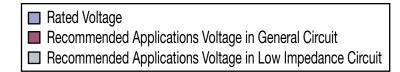
Capacitance		Rated Voltage								
μF	Code	6.3V (0J)	10V (1A)	16V (1C)	20V (1D)	25V (1E)	35V (1V)			
0.33	334						А			
0.47	474						А			
0.68	684					Α	Α			
1	105			Α	Α	A	В			
1.5	155				Α		В			
2.2	225			Α		В	В			
3.3	335	Α	Α	Α	В	В	С			
4.7	475		A/B	A/B	Α		С			
6.8	685					С	N			
10	106		A/B	A/B/C		C/N	N			
15	156	В	В			N				
22	226		A/B	B/C	C/N					
33	336	A/C	B/C	B/C/N						
47	476	В	B/C/N	C/N						
68	686		N							
100	107		С							

Released ratings

Please contact to your local KYOCERA AVX sales office when these series are being designed in your application.

Voltage vs Temperature Rating









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RATINGS & PART NUMBER REFERENCE

Part Number	Case Size	Capacitance	Rated	Leakage	DF@	ESR @	100kHz RMS Current (mA)			*1 ∆C/C	MSL
rai (Nullibei	Case Size	(μF)	Voltage (V)	Current (µA)	120Hz (%)	100kHz (Ω)	25°C	95°C	135°C	(%)	IVIOL
					6.3 V				_		
F970J335#AAHT3	Α	3.3	6.3	0.5	4	4.5	129	116	52	*	3
F970J156#BAHT3	В	15	6.3	0.9	6	2.0	206	186	82	*	3
F970J336#AAHT3	Α	33	6.3	2.1	12	2.5	173	156	69	*	3
F970J336#CCHT3	С	33	6.3	2.1	6	1.1	316	285	126	*	3
F970J476#BAHT3	В	47	6.3	3.0	8	1.0	292	262	117	*	3
					10 V						
F971A335#AAHT3	Α	3.3	10	0.5	4	4.5	129	116	52	*	3
F971A475#AAHT3	Α	4.7	10	0.5	6	4.0	137	123	55	*	3
F971A475#BAHT3	В	4.7	10	0.5	6	2.8	174	157	70	*	3
F971A106#AAHT3	Α	10	10	1.0	6	3.0	158	142	63	*	3
F971A106#BAHT3	В	10	10	1.0	6	2.0	206	186	82	*	3
F971A156#BAHT3	В	15	10	1.5	6	2.0	206	186	82	*	3
F971A226#AAHT3	Α	22	10	2.2	15	3.0	158	142	63	*	3
F971A226#BAHT3	В	22	10	2.2	8	1.9	212	190	85	*	3
F971A336#BAHT3	В	33	10	3.3	8	1.9	212	190	85	*	3
F971A336#CCHT3	С	33	10	3.3	6	1.1	316	285	126	*	3
F971A476#BAHT3	В	47	10	4.7	10	1.0	292	262	117	*	3
F971A476#CCHT3	С	47	10	4.7	8	0.9	350	315	140	*	3
F971A476#NCHT3	N	47	10	4.7	6	0.7	463	417	185	*	3
F971A686#NCHT3	N	68	10	6.8	6	0.6	500	450	200	*	3
F971A107#CCHT3	С	100	10	10.0	10	0.7	396	357	159	*	3
					16 V	olt					
F971C105#AAHT3	Α	1	16	0.5	4	7.5	100	90	40	*	3
F971C225#AAHT3	Α	2.2	16	0.5	4	5.0	122	110	49	*	3
F971C335#AAHT3	Α	3.3	16	0.5	4	4.5	129	116	52	*	3
F971C475#AAHT3	Α	4.7	16	0.8	8	4.0	137	123	55	*	3
F971C475#BAHT3	В	4.7	16	0.8	6	2.8	174	157	70	*	3
F971C106#AAHT3	Α	10	16	1.6	8	3.5	146	132	59	*	3
F971C106#BAHT3	В	10	16	1.6	6	2.1	201	181	80	*	3
F971C106#CCHT3	С	10	16	1.6	6	1.5	271	244	108	*	3
F971C226#BAHT3	В	22	16	3.5	8	1.9	212	190	85	*	3
F971C226#CCHT3	С	22	16	3.5	8	1.1	316	285	126	*	3
F971C336#BAHT3	В	33	16	5.3	10	2.1	201	181	80	*	3
F971C336#CCHT3	С	33	16	5.3	8	1.1	316	285	126	*	3
F971C336#NCHT3	N	33	16	5.3	6	0.7	463	417	185	*	3
F971C476#CCHT3	С	47	16	7.5	10	1.1	316	285	126	*	3
F971C476#NCHT3	N	47	16	7.5	8	0.7	463	417	185	*	3
					20 V	olt					
F971D105#AAHT3	Α	1	20	0.5	4	7.5	100	90	40	*	3
F971D155#AAHT3	Α	1.5	20	0.5	4	6.7	106	95	42	*	3
F971D335#BAHT3	В	3.3	20	0.7	4	3.1	166	149	66	*	3
F971D475#AAHT3	A	4.7	20	0.9	8	4.0	137	123	55	*	3
F971D226#CCHT3	С	22	20	4.4	8	1.1	316	285	126	*	3
F971D226#NCHT3	N	22	20	4.4	6	0.7	463	417	185	*	3
					25 V						
F971E684#AAHT3	Α	0.68	25	0.5	4	7.6	99	89	40	*	3
F971E105#AAHT3	A	1	25	0.5	4	7.5	100	90	40	*	3
F971E225#BAHT3	В	2.2	25	0.6	4	3.8	150	135	60	*	3
F971E335#BAHT3	В	3.3	25	0.8	4	3.5	156	140	62	*	3
F971E685#CCHT3	C	6.8	25	1.7	6	1.8	247	222	99	*	3
F971E106#CCHT3	C	10	25	2.5	6	1.6	262	236	105	*	3
F971E106#NCHT3	N	10	25	2.5	6	1.0	387	349	155	*	3
F971E156#NCHT3	N	15	25	3.8	6	0.7	463	417	185	*	3
	- '			0.0	35 V		100	17	100		
F971V334#AAHT3	A	0.33	35	0.5	4	12.0	79	71	32	*	3
F971V334#AAHT3	A	0.33	35	0.5	4	10.0	87	71	35	*	3
F971V684#AAHT3	A	0.47	35	0.5	4	7.6	99	89	40	*	3
										*	
F971V105#BAHT3	В	1	35	0.5	4	4.0	146	131	58	*	3
F971V155#BAHT3	В	1.5	35	0.5	4	4.0	146	131	58	*	3
F971V225#BAHT3	В	2.2	35	0.8	4	3.8	150	135	60		3
F971V335#CCHT3	C	3.3	35	1.2	4	2.0	235	211	94	*	3
F971V475#CCHT3	C	4.7	35	1.6	6	1.8	247	222	99	*	3
F971V685#NCHT3	N	6.8	35	2.4	6	1.0	387	349	155	*	3
F971V106#NCHT3	N	10	35	3.5	6	1.0	387	349	155	*	3

Item	All Case (%)		
Damp Heat	±10		
Temperature cycles	±5		
Resistance soldering heat	±5		
Surge	±5		
Endurance	±10		
Load Humidity	±10		

^{*1: \(\}Delta C/C \) Marked "*"



^{#:&}quot;N" for ±20% tolerance, "K" for ± 10% tolerance.
Moisture Sensitivity Level (MSL) is defined according to J-STD-020.



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QUALIFICATION TABLE

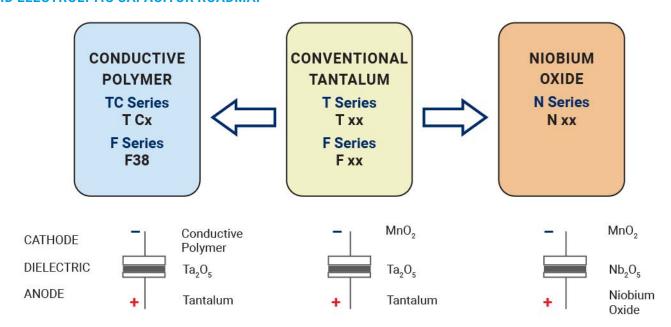
TEST	F97-HT3 series (Temperature range -55°C to +135°C)						
IESI	Condition						
Damp Heat (Steady State)	At 85°C, 85% RH For 1000 hours (No voltage applied) Capacitance Change						
Load Humidity	After 1000 hours application of rated voltage in series with a 33Ω resistor at 85°C, 85% RH capacitors meet the characteristics requirements table below. Capacitance Change Refer to the table above (*1) Dissipation Factor						
Temperature Cycles	At -55°C / +135°C,For 30 minutes each,1000 cycles Capacitance Change Refer to the table above (*1) Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less						
Resistance to Soldering Heat	10 seconds reow at 260°C, 5 seconds immersion at 260°C. Capacitance Change						
Solderability	After immersing capacitors completely into a solder pot at 245°C for 2 to 3 seconds, more than 3/4 of their electrode area shall remain covered with new solder.						
Surge*	After application of surge in series with a 33Ω resistor at the rate of 30 seconds ON, 30 seconds OFF, for 1000 successive test cycles at 95°C, capacitors shall meet the characteristic requirements table below. Capacitance ChangeRefer to the table above (*1) Dissipation FactorInitial specified value or less Leakage CurrentInitial specified value or less						
Endurance*	After 2000 hours application of rated voltage in series with a 3Ω resistor at 95°C,or derated voltage in series with a 3Ω resistor at 135°C,capacitors shall meet the characteristic requirements table below. Capacitance Change						
Shear Test	After applying the pressure load of 17.7N for 60 seconds horizontally to the center of capacitor side body which has no electrode and has been soldered beforehand on a substrate, there shall be found neither exfoliation nor its sign at the terminal electrode.						
Terminal Strength	Keeping a capacitor surface-mounted on a substrate upside down and supporting the substrate at both of the opposite bottom points 45mm apart from the center of capacitor, the pressure strength is applied with a specified jig at the center of the substrate so that substrate may bend by 1mm as illustrated. Then, there shall be found no remarkable abnormality on the capacitor terminals.						

 $^{\,{}^\}star\!$ As for the surge voltage and derated voltage at 135°C, refer to page precautions for details.





SOLID ELECTROLYTIC CAPACITOR ROADMAP



FIVE CAPACITOR CONSTRUCTION STYLES



SERIES LINE UP: CONVENTIONAL SMD MnO,

